

What is claimed is:

1. A surface-mounting type electronic circuit unit comprising:

a side electrode arranged on a side face;

5 a circuit substrate having a wiring pattern arranged on an upper face in a state connected to this side electrode; and

an electric part connected to said wiring pattern by soldering;

wherein said wiring pattern has a connecting conductor
10 electrically connecting said side electrode and said electric part, and said connecting conductor connecting said electric part arranged in a position very near said side electrode is formed in a bent state.

2. The surface-mounting type electronic circuit unit
15 according to claim 1, wherein said connecting conductor is formed in the bent state of a zigzag shape.

3. A surface-mounting type electronic circuit unit comprising:

a side electrode arranged on a side face;

20 a circuit substrate having a wiring pattern arranged on an upper face in a state connected to this side electrode; and

an electric part connected to said wiring pattern by soldering;

wherein said wiring pattern has a connecting conductor
25 electrically connecting said side electrode and said electric part, and a silk layer is formed on said connecting conductor connecting said electric part arranged in a position very near

said side electrode so as to cross this connecting conductor.

4. The surface-mounting type electronic circuit unit according to claim 3, wherein said connecting conductor is formed in a straight line shape.

5 5. The surface-mounting type electronic circuit unit according to claim 3, wherein said connecting conductor is formed in a bent state.

6. The surface-mounting type electronic circuit unit according to claim 5, wherein said connecting conductor is formed
10 in the bent state of a zigzag shape.